



WMP-EUP-008

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By: 

Date: 12/10/2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applic. No. : 10/056,770 Confirmation No. 4597
Applicant : Gottfried Ferber et al.
Filed : January 24, 2002
TC/A.U. : 2818
Examiner : Long K. Tran
Title : Semiconductor Module and Method for
Fabricating the Semiconductor Module
Docket No. : WMP-EUP-008
Customer No. : 24131

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Hon. Commissioner for Patents
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AMENDMENT under 37 C.F.R. § 1.116

S i r :

In response to the final Office action dated September 10, 2003, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks/Arguments begin on page 5 of this paper.